

FORM PTO 1449  
(REV 2-32)U.S. DEPARTMENT OF COMMERCE  
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File No. 96-41D1

Serial No.  
09/518,842

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ConklinFiling Date:  
March 3, 2000Group:  
1447

## U.S. PATENT DOCUMENTS

EXAMINER INITIAL	DOCUMENT NUMBER	DATE	NAME	CLASS	SUBCLASS	FILING DATE IF APPROPRIATE

## FOREIGN PATENT DOCUMENTS

EXAMINER INITIAL	DOCUMENT NUMBER	DATE	COUNTRY	CLASS	SUBCLASS	FILING DATE IF APPROPRIATE
BBB	A1 97/16549	05/09/97	PCT			
	A2 95/34653	12/21/98	PCT			

## OTHER DOCUMENTS (Including Author, Title, Date, Pertinent Patents, etc.)

BBB	A3	— Koman et al., J. Biol. Chem. 271: 20238-20241, 1996.				
	A4	— Hillier et al., WashU-Merck EST Project, Accession No. H02449, 1995.				
	A5	— Hillier et al., WashU-Merck EST Project, Accession No. R16073, 1995.				
	A6	— Hillier et al., WashU-Merck EST Project, Accession No. R31278, 1995.				
	A7	— Hillier et al., WashU-Merck EST Project, Accession No. R31794, 1995.				
	A8	— Hillier et al., WashU-Merck EST Project, Accession No. R62136, 1995.				
	A9	— Hillier et al., WashU-Merck EST Project, Accession No. R62240, 1995.				
	A10	— Hillier et al., WashU-Merck EST Project, Accession No. R67799, 1995.				
	A11	— Hillier et al., WashU-Merck EST Project, Accession No. R68426, 1995.				
	A12	— Hillier et al., WashU-Merck EST Project, Accession No. R77100, 1995.				
	A13	— Hillier et al., WashU-Merck EST Project, Accession No. R75651, 1995.				
	A14	— Hillier et al., WashU-Merck EST Project, Accession No. R77804, 1995.				
BBB	A15	— Hillier et al., WashU-Merck EST Project, Accession No. H02448, 1995.				

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Examiner	Date considered
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Budget C. Bunner

7/11/2001

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